

# 1M x 1 Static RAM

#### **Features**

- · High speed
  - $-t_{AA} = 12 \text{ ns}$
- · CMOS for optimum speed/power
- Low active power
  - -825 mW
- Low standby power
  - 275 mW
- 2.0V data retention (optional)
  - 100 uW
- · Automatic power-down when deselected
- · TTL-compatible inputs and outputs

#### **Functional Description**

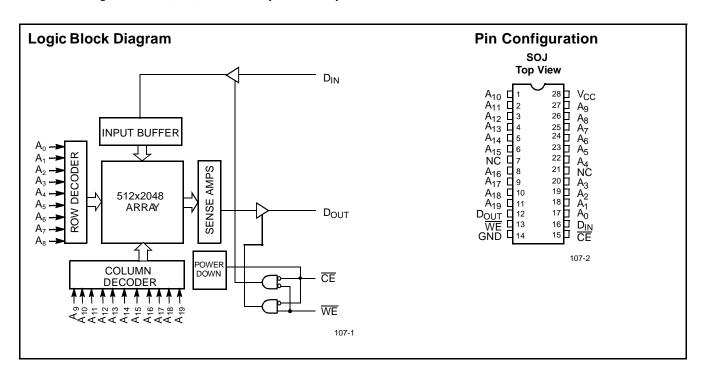
The CY7C107 and CY7C1007 are high-performance CMOS static RAMs organized as 1,048,576 words by 1 bit. Easy memory expansion is provided by an active LOW chip enable (CE) and three-state drivers. These devices have an automatic power-down feature that reduces power consumption by more than 65% when deselected.

Writing to the devices is accomplished by taking chip enable (CE) and write enable (WE) inputs LOW. Data on the input pin (DIN) is written into the memory location specified on the address pins ( $A_0$  through  $A_{19}$ ).

Reading from the devices is accomplished by taking chip enable (CE) LOW while write enable (WE) remains HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the data output (DOUT)

The output pin (DOUT) is placed in a high-impedance state when the device is deselected (CE HIGH) or during a write operation (CE and WE LOW).

The CY7C107 is available in a standard 400-mil-wide SOJ; the CY7C1007 is available in a standard 300-mil-wide SOJ.



#### **Selection Guide**

	7C107-12 7C1007-12	7C107-15 7C1007-15	7C107-20 7C1007-20	7C107-25 7C1007-25	7C107-35
Maximum Access Time (ns)	12	15	20	25	35
Maximum Operating Current (mA)	150	135	125	120	110
Maximum Standby Current (mA)	50	40	30	30	25



#### **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature .....-65°C to +150°C Ambient Temperature with Power Applied......-55°C to +125°C Supply Voltage on  $V_{CC}$  Relative to  $GND^{[1]}$ .....-0.5V to +7.0V DC Input Voltage<sup>[1]</sup>......-0.5V to V<sub>CC</sub> + 0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage	>2001V
(per MIL-STD-883, Method 3015)	
Latch-Up Current	.>200 mA

## **Operating Range**

Range	Ambient Temperature <sup>[2]</sup>	V <sub>CC</sub>
Commercial	0°C to +70°C	5V ± 10%

# **Electrical Characteristics** Over the Operating Range

				07-12 007-12		07-15 007-15		07-20 007-20	
Parameter	Description	Test Conditions	Min.	Max.	Min.	Max.	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	$V_{CC} = Min., I_{OH} = -4.0 \text{ mA}$	2.4		2.4		2.4		V
V <sub>OL</sub>	Output LOW Voltage	$V_{CC} = Min., I_{OL} = 8.0 \text{ mA}$		0.4		0.4		0.4	V
V <sub>IH</sub>	Input HIGH Voltage		2.2	V <sub>CC</sub> + 0.3	2.2	V <sub>CC</sub> + 0.3	2.2	V <sub>CC</sub> + 0.3	V
V <sub>IL</sub>	Input LOW Voltage <sup>[1]</sup>		-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I <sub>IX</sub>	Input Load Current	$GND \le V_1 \le V_{CC}$	-1	+1	-1	+1	-1	+1	μΑ
I <sub>OZ</sub>	Output Leakage Current	$\begin{aligned} & \text{GND} \leq \text{V}_{\text{I}} \leq \text{V}_{\text{CC}}, \\ & \text{Output Disabled} \end{aligned}$	<del>-</del> 5	+5	<b>-</b> 5	+5	-5	+5	μΑ
I <sub>OS</sub>	Output Short Circuit Current <sup>[3]</sup>	$V_{CC} = Max., V_{OUT} = GND$		-300		-300		-300	mA
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0 \text{ mA},$ $f = f_{MAX} = 1/t_{RC}$		150		135		125	mA
I <sub>SB1</sub>	Automatic CE Power-Down Current — TTL Inputs	$\begin{split} & \underbrace{\text{Max V}_{CC}}, \\ & \underbrace{\text{CE}} \geq \text{V}_{IH}, \\ & \text{V}_{IN} \geq \text{V}_{IH} \text{ or } \\ & \text{V}_{IN} \leq \text{V}_{IL}, \\ & \text{f} = \text{f}_{MAX} \end{split}$		50		40		30	mA
I <sub>SB2</sub>	Automatic CE Power-Down Current — CMOS Inputs	$\begin{split} &\frac{\text{Max. V}_{\text{CC}},}{\text{CE}} \geq \text{V}_{\text{CC}} - 0.3\text{V},\\ &\text{V}_{\text{IN}} \geq \text{V}_{\text{CC}} - 0.3\text{V or}\\ &\text{V}_{\text{IN}} \leq 0.3\text{V}, \text{f=0} \end{split}$		2		2		2	mA

#### Notes:

- 1.  $V_{IL}$  (min.) = -2.0V for pulse durations of less than 20 ns. 2.  $T_A$  is the "instant on" case temperature.
- 3. Not more than 1 output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.



# **Electrical Characteristics** Over the Operating Range (continued)

				107-25 1007-25	7C		
Parameter	Description	Test Conditions	Min.	Max.	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	$V_{CC} = Min., I_{OH} = -4.0 \text{ mA}$	2.4		2.4		V
V <sub>OL</sub>	Output LOW Voltage	$V_{CC} = Min., I_{OL} = 8.0 \text{ mA}$		0.4		0.4	V
V <sub>IH</sub>	Input HIGH Voltage		2.2	V <sub>CC</sub> +0.3	2.2	V <sub>CC</sub> + 0.3	V
V <sub>IL</sub>	Input LOW Voltage <sup>[1]</sup>		-0.3	0.8	-0.3	0.8	V
I <sub>IX</sub>	Input Load Current	$GND \le V_1 \le V_{CC}$	-1	+1	-1	+1	μΑ
I <sub>OZ</sub>	Output Leakage Current	$\begin{aligned} &\text{GND} \leq \text{V}_{\text{I}} \leq \text{V}_{\text{CC}}, \\ &\text{Output Disabled} \end{aligned}$	-5	+5	-5	+5	μΑ
I <sub>OS</sub>	Output Short Circuit Current <sup>[3]</sup>	V <sub>CC</sub> = Max., V <sub>OUT</sub> = GND		-300		-300	mA
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0mA,$ $f = f_{MAX} = 1/t_{RC}$		120		110	mA
I <sub>SB1</sub>	Automatic CE Power-Down Current — TTL Inputs	$\label{eq:max.vcc} \begin{split} & \underbrace{Max}_{CE} & V_{CC}, \\ & \overline{CE} \geq V_{IH}, \\ & V_{IN} \geq V_{IH} \text{ or } \\ & V_{IN} \leq V_{IL}, \\ & f = f_{MAX} \end{split}$		30		25	mA
I <sub>SB2</sub>	Automatic CE Power-Down Current — CMOS Inputs	$\begin{array}{l} \underline{\text{Max. V}_{CC}},\\ \overline{\text{CE}} \geq \text{V}_{CC} \text{- } 0.3\text{V},\\ \text{V}_{\text{IN}} \geq \text{V}_{CC} \text{- } 0.3\text{V or}\\ \text{V}_{\text{IN}} \leq 0.3\text{V}, \text{f=0} \end{array}$		2		2	mA

# Capacitance<sup>[4]</sup>

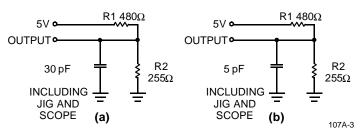
Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub> : Addresses	Input Capacitance	$T_A = 25^{\circ}C$ , $f = 1$ MHz,	7	pF
C <sub>IN</sub> : Controls		$V_{CC} = 5.0V$	10	pF
C <sub>OUT</sub>	Output Capacitance		10	pF

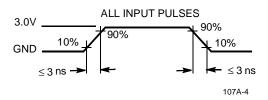
Note

<sup>4.</sup> Tested initially and after any design or process changes that may affect these parameters.



### **AC Test Loads and Waveforms**





Equivalent to: THÉVENIN EQUIVALENT

OUTPUT • **--•** 1.73∨

## Switching Characteristics<sup>[5]</sup> Over the Operating Range

			07-12 07-12		07-15 07-15		07-20 07-20		07-25 07-25	7C10	7-35	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYC	LE	•	•	•		•		•				
t <sub>RC</sub>	Read Cycle Time	12		15		20		25		35		ns
t <sub>AA</sub>	Address to Data Valid		12		15		20		25		35	ns
t <sub>OHA</sub>	Data Hold from Address Change	3		3		3		3		3		ns
t <sub>ACE</sub>	CE LOW to Data Valid		12		15		20		25		35	ns
t <sub>LZCE</sub>	CE LOW to Low Z <sup>[6]</sup>	3		3		3		3		3		ns
t <sub>HZCE</sub>	CE HIGH to High Z <sup>[6,7]</sup>		6		7		8		10		10	ns
t <sub>PU</sub>	CE LOW to Power-Up	0		0		0		0		0		ns
t <sub>PD</sub>	CE HIGH to Power-Down		12		15		20		25		35	ns
WRITE CYC	CLE <sup>[8]</sup>	•	•	•		•		•				
t <sub>WC</sub>	Write Cycle Time	12		15		20		25		35		ns
t <sub>SCE</sub>	CE LOW to Write End	10		12		15		20		25		ns
t <sub>AW</sub>	Address Set-Up to Write End	10		12		15		20		25		ns
t <sub>HA</sub>	Address Hold from Write End	0		0		0		0		0		ns
t <sub>SA</sub>	Address Set-Up to Write Start	0		0		0		0		0		ns
t <sub>PWE</sub>	WE Pulse Width	10		12		15		20		25		ns
t <sub>SD</sub>	Data Set-Up to Write End	7		8		10		15		20		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		0		0		ns
t <sub>LZWE</sub>	WE HIGH to Low Z <sup>[6]</sup>	3		3		3		3		3		ns
t <sub>HZWE</sub>	WE LOW to High Z <sup>[6,7]</sup>		6		7		8		10		10	ns

#### Notes:

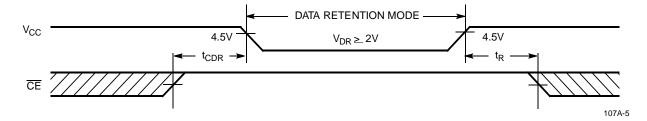
- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified  $I_{OL}I_{OH}$  and 30-pF load capacitance.
- At any given temperature and voltage condition,  $t_{HZCE}$  is less than  $t_{LZCE}$  and  $t_{HZWE}$  is less than  $t_{LZWE}$  for any given device.  $t_{HZCE}$  and  $t_{HZWE}$  are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured  $\pm 500$  mV from steady-state voltage.
- The internal write time of the memory is defined by the overlap of  $\overline{CE}$  LOW and  $\overline{WE}$  LOW.  $\overline{CE}$  and  $\overline{WE}$  must be LOW to initiate a write, and the transition of any of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.



## Data Retention Characteristics Over the Operating Range (L Version Only)

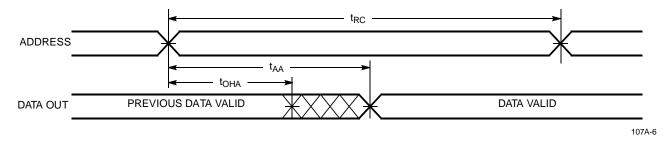
Parameter	Description	Conditions <sup>[9]</sup>	Min.	Max.	Unit
$V_{DR}$	V <sub>CC</sub> for Data Retention		2.0		V
I <sub>CCDR</sub>	Data Retention Current	$\frac{V_{CC}}{2} = V_{DR} = 2.0V,$		50	μΑ
t <sub>CDR</sub> <sup>[4]</sup>	Chip Deselect to Data Retention Time	$CE \ge V_{CC} - 0.3V$ , $V_{IN} \ge V_{CC} - 0.3$ or	0		ns
t <sub>R</sub> <sup>[4]</sup>	Operation Recovery Time	V <sub>IN</sub> ≤ 0.3V	t <sub>RC</sub>		ns

### **Data Retention Waveform**

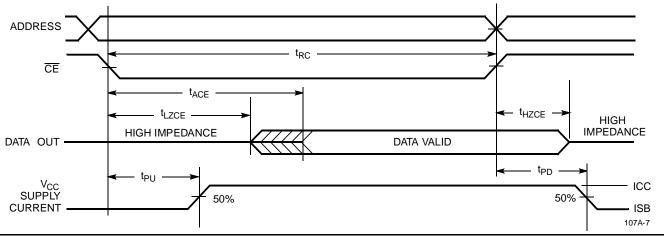


## **Switching Waveforms**

Read Cycle No. 1<sup>[10, 11]</sup>



Read Cycle No. 2<sup>[11, 12]</sup>



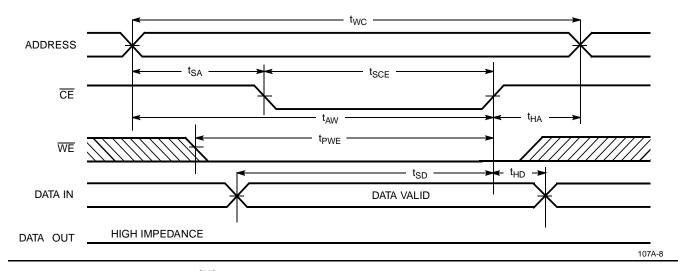
#### Notes:

- No input may exceed V<sub>CC</sub> + 0.5V.
   Device is continuously selected, \( \overline{CE} = V\_{|L}. \)
   WE is HIGH for read cycle.
   Address valid prior to or coincident with \( \overline{CE} \) transition LOW.

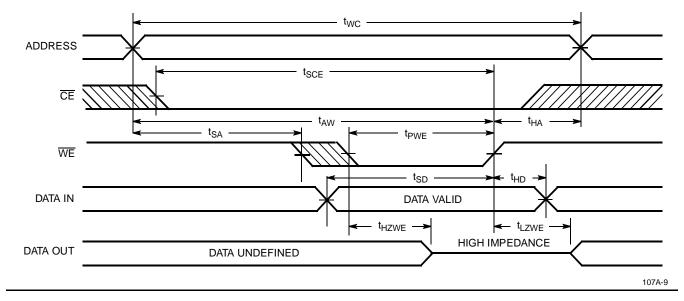


# Switching Waveforms (continued)

Write Cycle No. 1 (CE Controlled)<sup>[13]</sup>



# Write Cycle No. 2 (WE Controlled)<sup>[13]</sup>



#### Note:

13. If  $\overline{\text{CE}}$  goes HIGH simultaneously with  $\overline{\text{WE}}$  going HIGH, the output remains in a high-impedance state.

## **Truth Table**

CE	WE	D <sub>OUT</sub>	Mode	Power
Н	Х	High Z	Power-Down	Standby (I <sub>SB</sub> )
L	Н	Data Out	Read	Active (I <sub>CC</sub> )
L	L	High Z	Write	Active (I <sub>CC</sub> )



# **Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C107-12VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1007-12VC	V21	28-Lead (300-Mil) Molded SOJ	
15	CY7C107-15VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1007-15VC	V21	28-Lead (300-Mil) Molded SOJ	
20	CY7C107-20VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1007-20VC	V21	28-Lead (300-Mil) Molded SOJ	
25	CY7C107-25VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1007-25VC	V21	28-Lead (300-Mil) Molded SOJ	
35	CY7C107-35VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial

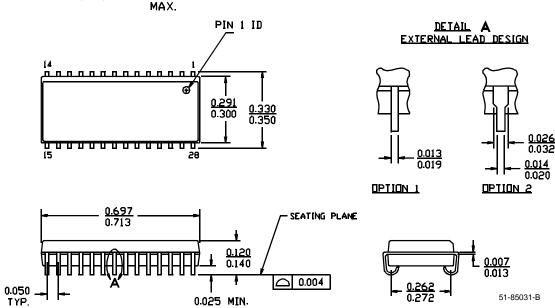
Contact factory for "L" version availability.

Document #: 38-00232-B

Package Diagrams

### 28-Lead (300-Mil) Molded SOJ V21

# DIMENSIONS IN INCHES MIN. MAX.





## Package Diagrams (continued)

#### 28-Lead (400-Mil) Molded SOJ V28

